
HM62W256 Series

256 k SRAM (32-kword × 8-bit)

HITACHI

ADE-203-084H (Z)

Rev. 8.0

Nov. 1997

Features

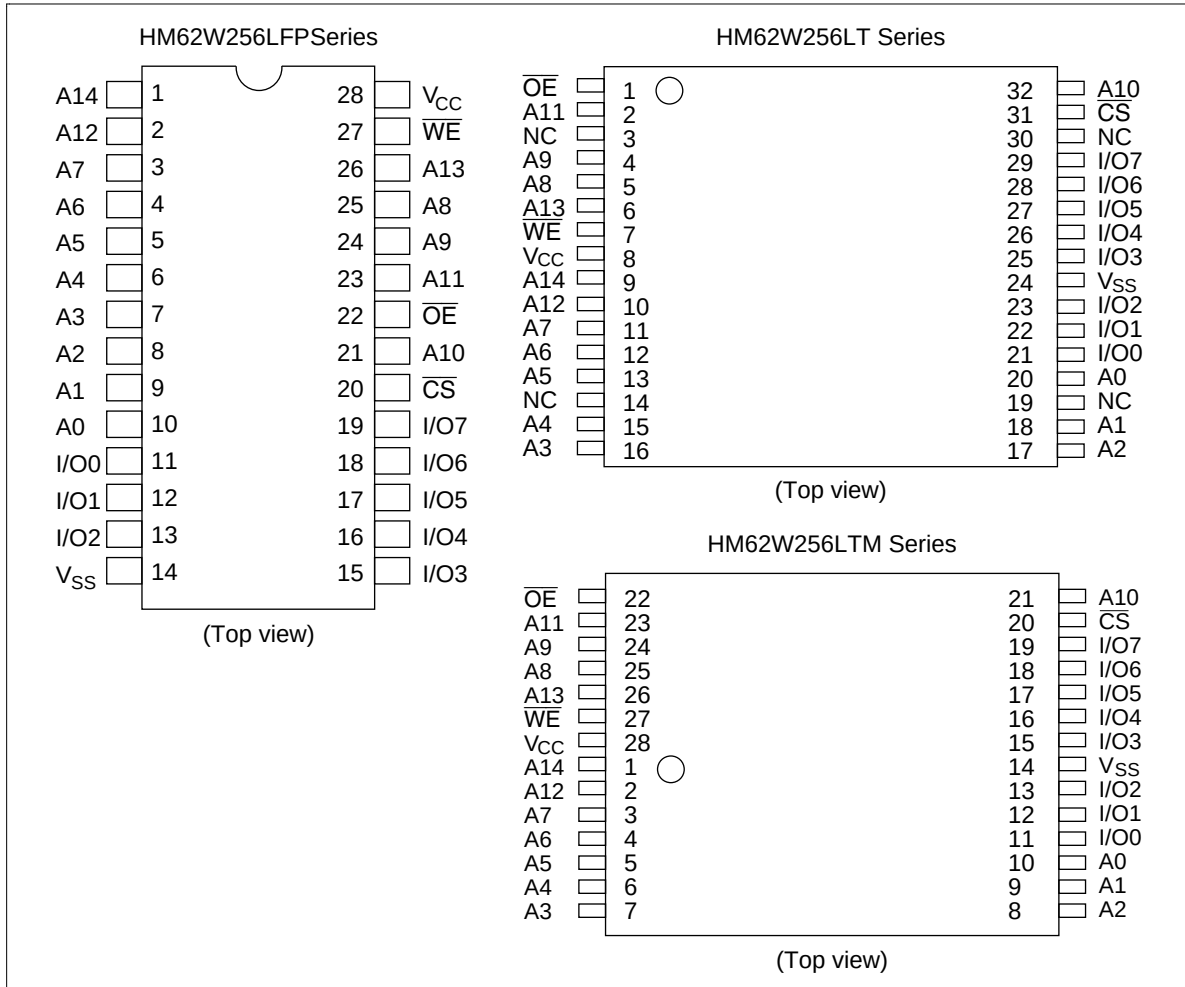
- Low voltage operation SRAM
Operating Supply Voltage: 3.0 V to 3.6 V
- 0.8 μm Hi-CMOS process
- High speed
Access time: 55/70/85 ns (max)
- Low power
Standby: 0.33 μW (typ)
- Completely static memory
No clock or timing strobe required
- Directly LVTTTL compatible: All inputs and outputs

Ordering Information

Type No.	Access Time	Package
HM62W256LFP-7T	70 ns	450 mil 28-pin plastic SOP (FP-28DA)
HM62W256LFP-5SLT	55 ns	
HM62W256LFP-7SLT	70 ns	
HM62W256LFP-8SLT	85 ns	
HM62W256LFP-7ULT	70 ns	8 mm × 14 mm 32-pin TSOP (normal type) (TFP-32DA)
HM62W256LT-7	70 ns	
HM62W256LT-7SL	70 ns	
HM62W256LT-8SL	85 ns	
HM62W256LTM-7	70 ns	8 mm × 13.4 mm 28-pin TSOP (normal type) (TFP-28DA)
HM62W256LTM-5SL	55 ns	
HM62W256LTM-7SL	70 ns	
HM62W256LTM-8SL	85 ns	
HM62W256LTM-7UL	70 ns	

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Pin Arrangement



Pin Description

Pin name	Function
A0 – A14	Address inputs
I/O0 – I/O7	Input/output
CS	Chip select
WE	Write enable
OE	Output enable
NC	No connection
V _{CC}	Power supply
V _{SS}	Ground

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Function Table

$\overline{WE}$	$\overline{CS}$	$\overline{OE}$	Mode	V_{CC} Current	I/O Pin	Ref. Cycle
X	H	X	Not selected	I_{SB}, I_{SB1}	High-Z	—
H	L	H	Output disable	I_{CC}	High-Z	—
H	L	L	Read	I_{CC}	Dout	Read cycle (1)–(3)
L	L	H	Write	I_{CC}	Din	Write cycle (1)
L	L	L	Write	I_{CC}	Din	Write cycle (2)

Note: X: H or L

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Power supply voltage ^{*1}	V_{CC}	–0.5 to 4.6	V
Terminal voltage ^{*1}	V_T	–0.5 ^{*2} to $V_{CC} + 0.5$ ^{*3}	V
Power dissipation	P_T	1.0	W
Operating temperature	T_{opr}	0 to +70	°C
Storage temperature	T_{stg}	–55 to +125	°C
Storage temperature under bias	T_{bias}	–10 to +85	°C

Notes: 1. Relative to V_{SS}
 2. V_T min: –3.0 V for pulse half-width ≤ 50 ns
 3. Maximum voltage is 4.6 V

Recommended DC Operating Conditions ($T_a = 0$ to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{CC}	3.0	3.3	3.6	V
	V_{SS}	0	0	0	V
Input high(logic 1) voltage	V_{IH}	2.0	—	$V_{CC} + 0.3$	V
Input low(logic 0) voltage	V_{IL}	–0.3 ^{*1}	—	0.8	V

Note: 1. V_{IL} min: –3.0 V for pulse half-width ≤ 50 ns

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DC Characteristics (Ta = 0 to +70°C, V_{CC} = 3.3 V ± 0.3 V, V_{SS} = 0 V)

Parameter	Symbol	Min	Typ ¹	Max	Unit	Test conditions
Input leakage current	I _{LI}	—	—	1	μA	V _{SS} ≤ Vin ≤ V _{CC}
Output leakage current	I _{LO}	—	—	1	μA	$\overline{CS} = V_{IH}$ or $\overline{OE} = V_{IH}$ or $\overline{WE} = V_{IL}$, V _{SS} ≤ V _{I/O} ≤ V _{CC}
Operating power supply current (DC)	I _{CCDC1}	—	—	15	mA	$\overline{CS} = V_{IL}$, others = V _{IH} /V _{IL} I _{I/O} = 0 mA
	I _{CCDC2}	—	—	10	mA	$\overline{CS} \leq 0.2$ V, V _{IH} ≥ V _{CC} − 0.2 V, V _{IL} ≤ 0.2 V, I _{I/O} = 0 mA
Average operating power supply current	HM62W256-5 I _{CCAC1}	—	—	30	mA	min cycle, duty = 100 %, $\overline{CS} = V_{IL}$, others = V _{IH} /V _{IL} I _{I/O} = 0 mA
	HM62W256-7 I _{CCAC1}	—	—	30		
	HM62W256-8 I _{CCAC1}	—	—	27		
	I _{CCAC2}	—	—	15	mA	Cycle time ≥ 1 μs, duty = 100% I _{I/O} = 0 mA, $\overline{CS} \leq 0.2$ V, V _{IH} ≥ V _{CC} − 0.2 V, V _{IL} ≤ 0.2 V
Standby power supply current	I _{SB}	—	0.1	1	mA	$\overline{CS} = V_{IH}$
	I _{SB1}	—	0.1	50	μA	Vin ≥ 0 V, $\overline{CS} \geq V_{CC} - 0.2$ V,
		—	0.1	10 ⁺²		
		—	0.1	5 ⁺³		
Output low voltage	V _{OL}	—	—	0.4	V	I _{OL} = 2.0 mA
		—	—	0.2	V	I _{OL} = 100 μA
Output high voltage	V _{OH}	V _{CC} − 0.2	—	—	V	I _{OH} = −100 μA
		2.4	—	—	V	I _{OH} = −2.0 mA

Notes: 1. Typical values are at V_{CC} = 3.3 V, Ta = +25°C and not guaranteed.
2. This characteristic is guaranteed only for L-SL version.
3. This characteristic is guaranteed only for L-UL version.

Capacitance (Ta = 25°C, f = 1.0 MHz)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Input capacitance ¹	C _{in}	—	—	5	pF	Vin = 0 V
Input/output capacitance ¹	C _{I/O}	—	—	8	pF	V _{I/O} = 0 V

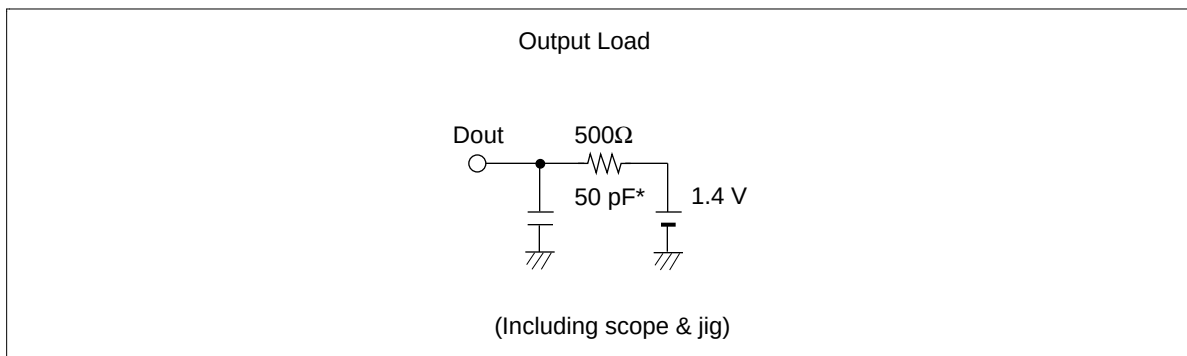
Note: 1. This parameter is sampled and not 100% tested.

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AC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, unless otherwise noted.)

Test Conditions

- Input pulse levels: 0.4 V to 2.4 V
- Input rise and fall time: 5 ns
- Input reference level: 1.4 V
- Output timing reference level: HM62W256-5: 1.4 V
HM62W256-7/8: 0.8 V/2.0 V

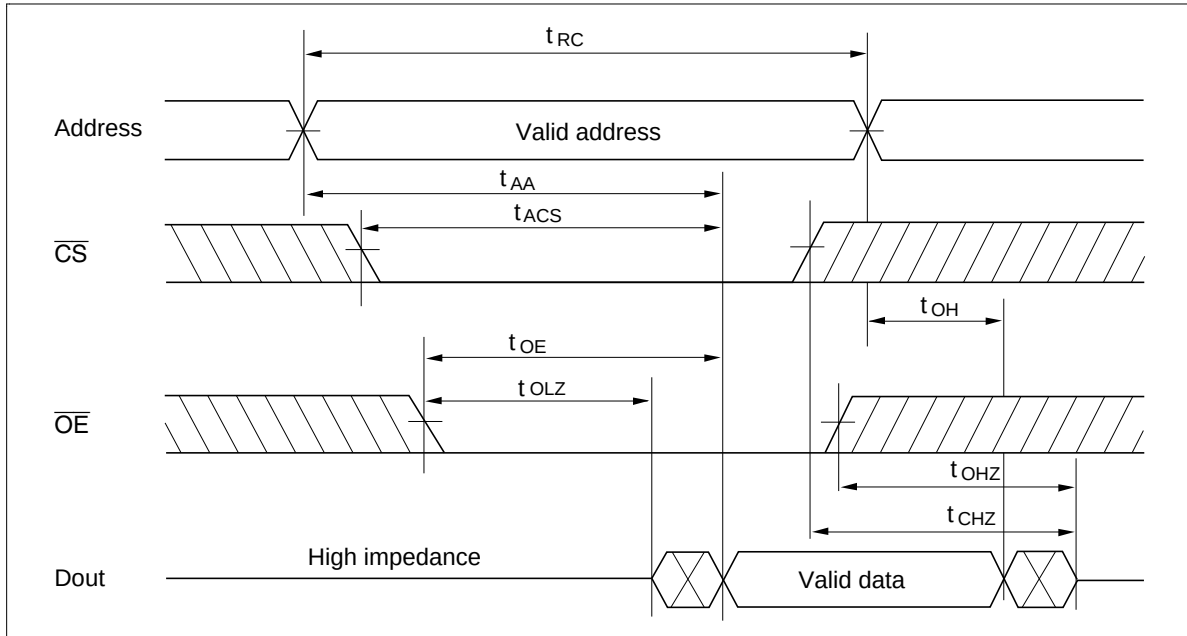


Read Cycle

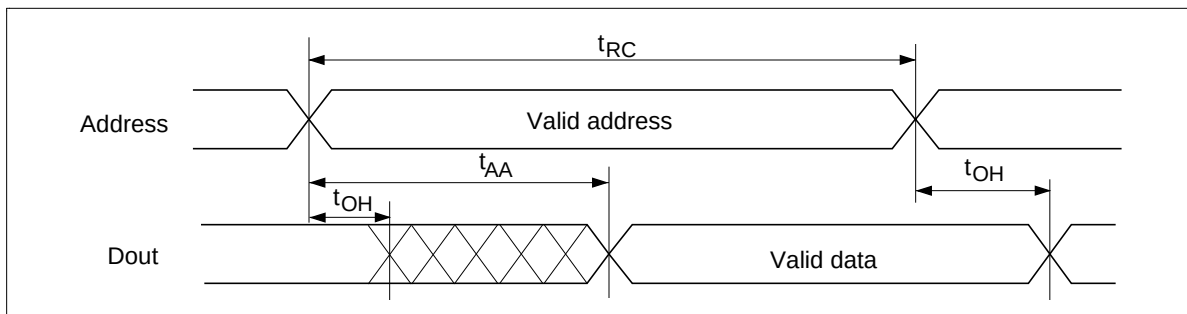
		HM62W256							
		-5		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Read cycle time	t_{RC}	55	—	70	—	85	—	ns	
Address access time	t_{AA}	—	55	—	70	—	85	ns	
Chip select access time	t_{ACS}	—	55	—	70	—	85	ns	
Output enable to output valid	t_{OE}	—	30	—	35	—	45	ns	
Chip selection to output in low-Z	t_{CLZ}	5	—	10	—	10	—	ns	2
Output enable to output in low-Z	t_{OLZ}	5	—	5	—	5	—	ns	2
Chip deselection to output in high-Z	t_{CHZ}	0	20	0	25	0	30	ns	1, 2
Output disable to output in high-Z	t_{OHZ}	0	20	0	25	0	30	ns	1, 2
Output hold from address change	t_{OH}	10	—	10	—	10	—	ns	

Notes: 1. t_{CHZ} and t_{OHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.
2. This parameter is sampled and not 100% tested.

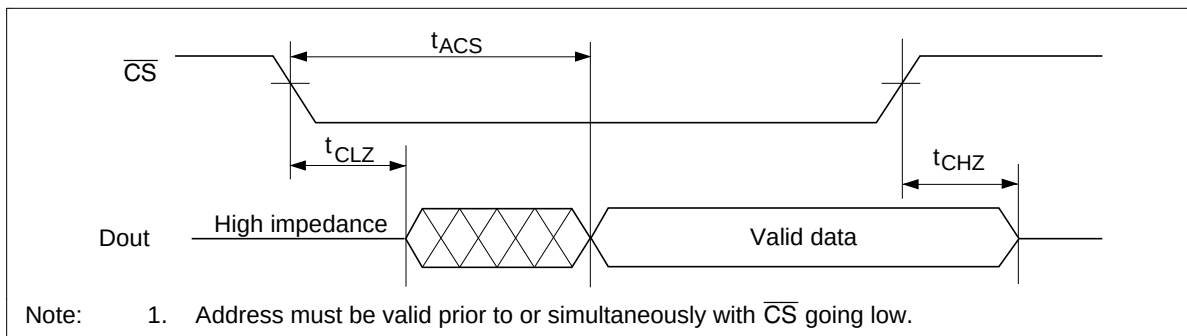
Read Timing Waveform (1) ($\overline{WE} = V_{IH}$)



Read Timing Waveform (2) ($\overline{WE} = V_{IH}$, $\overline{CS} = V_{IL}$, $\overline{OE} = V_{IL}$)



Read Timing Waveform (3) ($\overline{WE} = V_{IH}$, $\overline{OE} = V_{IL}$)*1



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Write Cycle

		HM62W256							
		-5		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write cycle time	t _{WC}	55	—	70	—	85	—	ns	
Chip selection to end of write	t _{CW}	45	—	60	—	75	—	ns	4
Address setup time	t _{AS}	0	—	0	—	0	—	ns	5
Address valid to end of write	t _{AW}	45	—	60	—	75	—	ns	
Write pulse width	t _{WP}	40	—	50	—	55	—	ns	3, 8
Write recovery time	t _{WR}	0	—	0	—	0	—	ns	6
Write to output in high-Z	t _{WHZ}	0	25	0	25	0	30	ns	1, 2, 7
Data to write time overlap	t _{DW}	30	—	30	—	35	—	ns	
Data hold from write time	t _{DH}	0	—	0	—	0	—	ns	
Output active from end of write	t _{OW}	10	—	10	—	10	—	ns	2
Output disable to output in high-Z	t _{OHZ}	0	20	0	25	0	30	ns	1, 2, 7

Notes: 1. t_{OHZ} and t_{WHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.

2. This parameter is samples and not 100% tested.

3. A write occurs during the overlap (t_{WP}) of a low $\overline{CS}$ and a low $\overline{WE}$. A write begins at the later transition of $\overline{CS}$ going low or $\overline{WE}$ going low. A write ends at the earlier transition of $\overline{CS}$ going high or $\overline{WE}$ going high. t_{WP} is measured from the beginning of write to the end of write.

4. t_{CW} is measured from $\overline{CS}$ going low to the end of write.

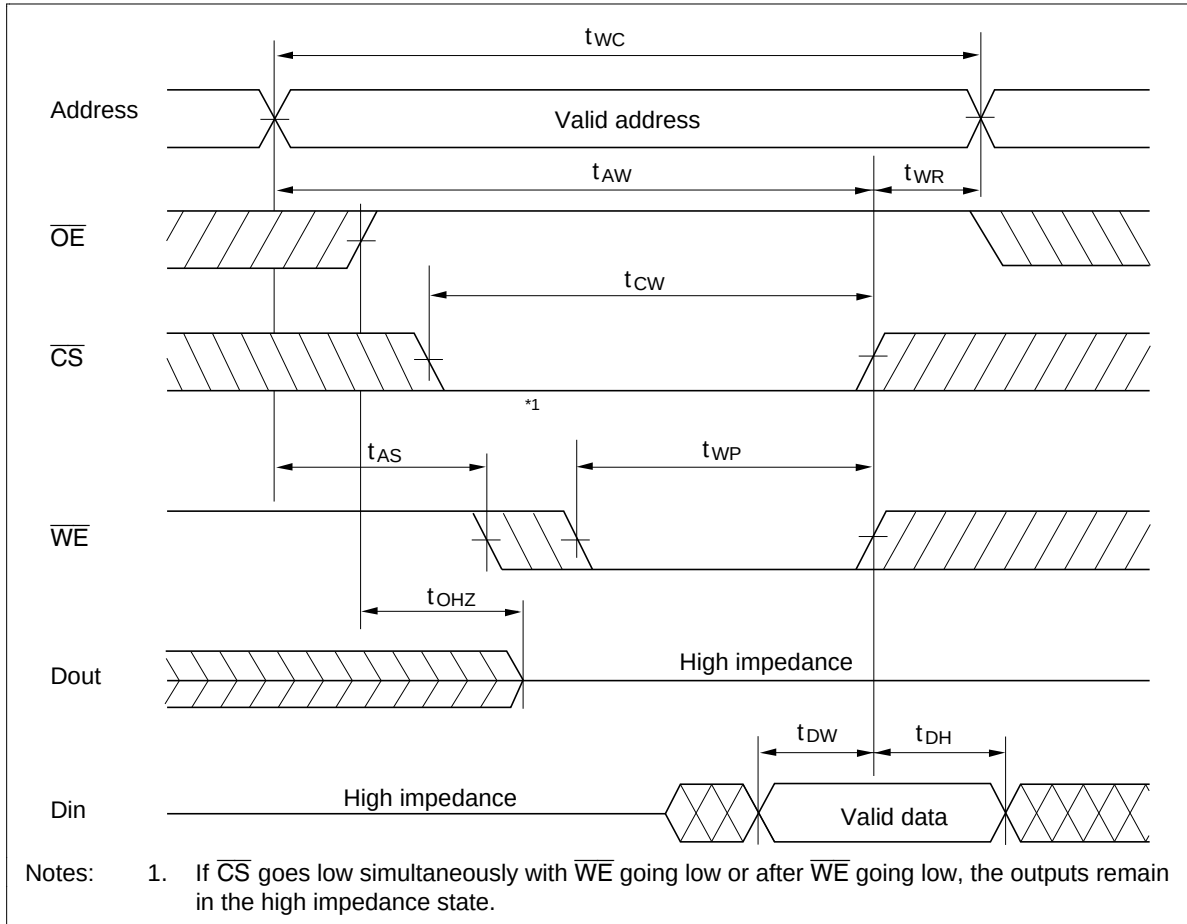
5. t_{AS} is measured from the address valid to the beginning of write.

6. t_{WR} is measured from the earlier of $\overline{WE}$ or $\overline{CS}$ going high to the end of write cycle.

7. During this period, I/O pins are in the output state so that the input signals of the opposite phase to the outputs must not be applied.

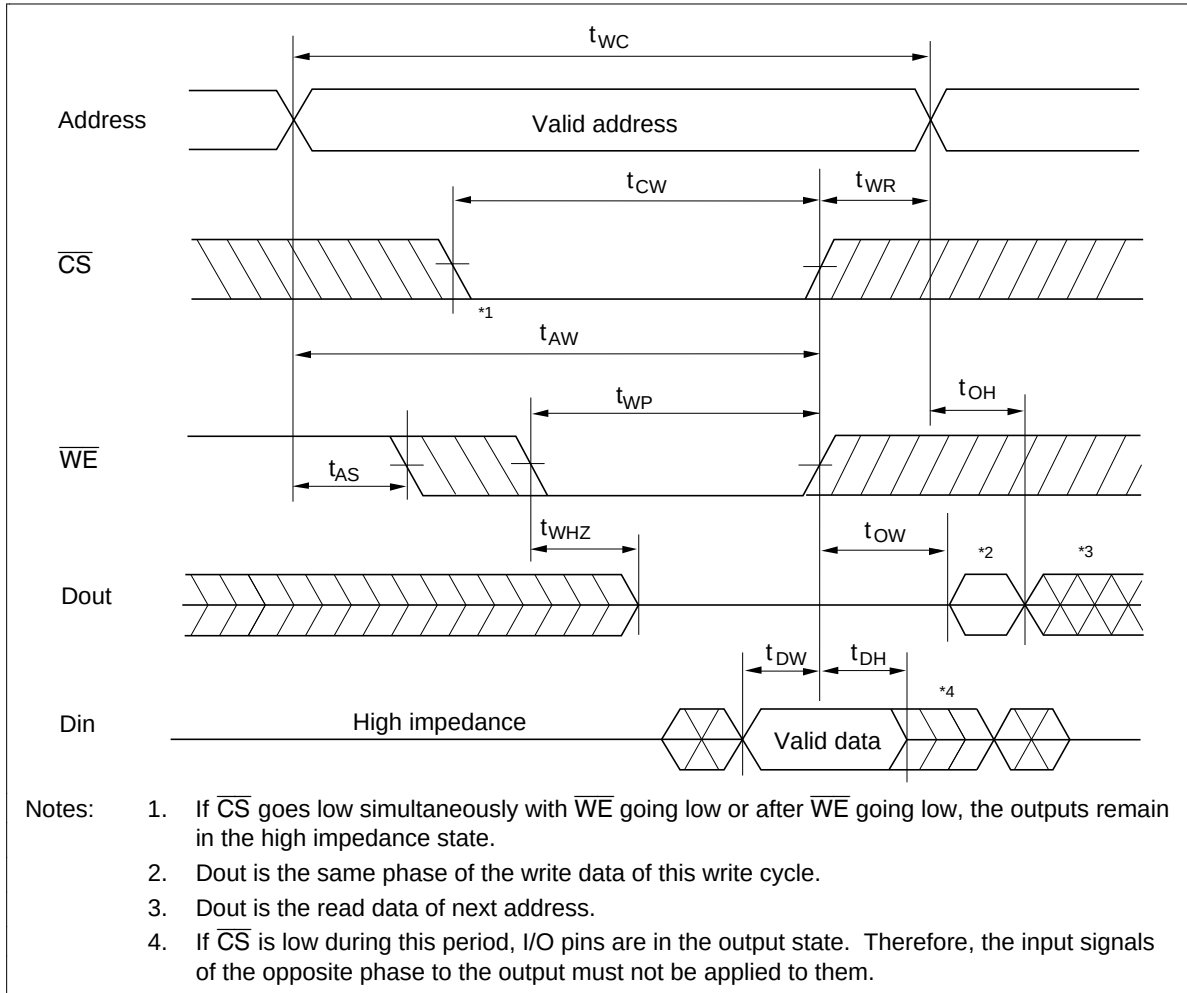
8. In the write cycle with $\overline{OE}$ low fixed, t_{WP} must satisfy the following equation to avoid a problem of data bus contention, $t_{WP} \geq t_{WHZ} \max + t_{DW} \min$.

Write Timing Waveform (1) ($\overline{\text{OE}}$ Clock)



HM62W256 Series

Write Timing Waveform (2) ($\overline{\text{OE}}$ Low Fixed)

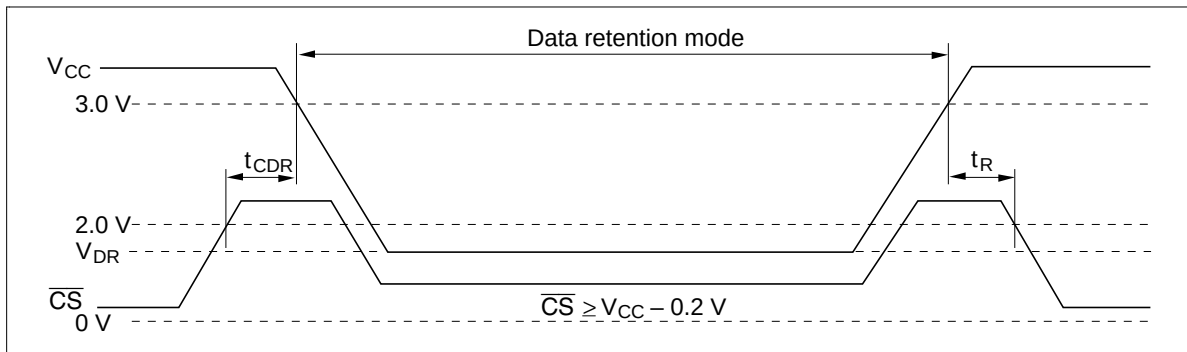


Low V_{CC} Data Retention Characteristics ($T_a = 0$ to $+70^\circ\text{C}$)

Parameter	Symbol	Min	Typ ^{*1}	Max	Unit	Test conditions ^{*6}
V_{CC} for data retention	V_{DR}	2.0	—	3.6	V	$\overline{CS} \geq V_{CC} - 0.2 \text{ V}$, $V_{in} \geq 0 \text{ V}$
Data retention current	I_{CCDR}	—	0.05	30^{*2}	μA	$V_{CC} = 3.0 \text{ V}$, $V_{in} \geq 0 \text{ V}$ $\overline{CS} \geq V_{CC} - 0.2 \text{ V}$,
		—	0.05	8^{*3}		
		—	0.05	3^{*4}		
Chip deselect to data retention time	t_{CDR}	0	—	—	ns	See retention waveform
Operation recovery time	t_R	t_{RC}^{*5}	—	—	ns	

- Notes: 1. Typical values are at $V_{CC} = 3.0 \text{ V}$, $T_a = 25^\circ\text{C}$ and not guaranteed.
2. $10 \mu\text{A}$ max. at $T_a = 0$ to $+40^\circ\text{C}$.
3. This characteristics guaranteed for only L-SL version. $2.5 \mu\text{A}$ max. at $T_a = 0$ to $+40^\circ\text{C}$.
4. This characteristics guaranteed for only L-UL version. $0.6 \mu\text{A}$ max. at $T_a = 0$ to $+40^\circ\text{C}$.
5. t_{RC} = read cycle time.
6. $\overline{CS}$ controls address buffer, $\overline{WE}$ buffer, $\overline{OE}$ buffer, and Din buffer. If $\overline{CS}$ controls data retention mode, other input levels (address, $\overline{WE}$, $\overline{OE}$, I/O) can be in the high impedance state.

Low V_{CC} Data Retention Timing Waveform

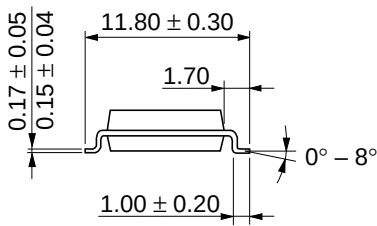
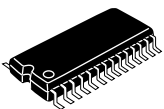
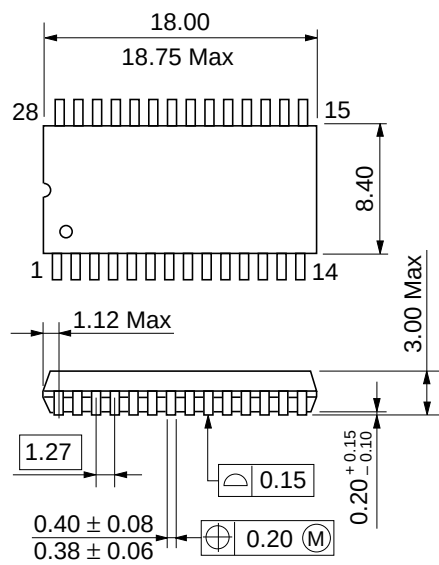


HM62W256 Series

Package Dimensions

HM62W256LFP Series (FP-28DA)

Unit: mm

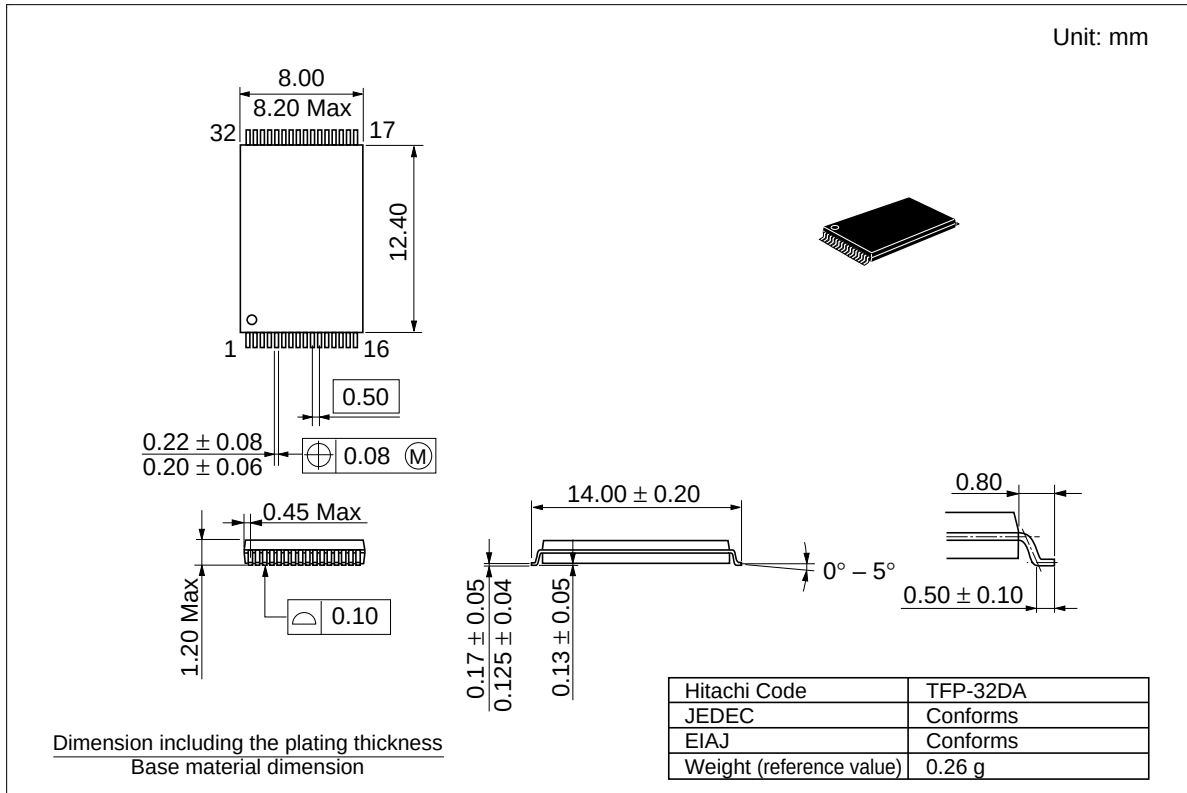


Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-28DA
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.82 g

Package Dimensions

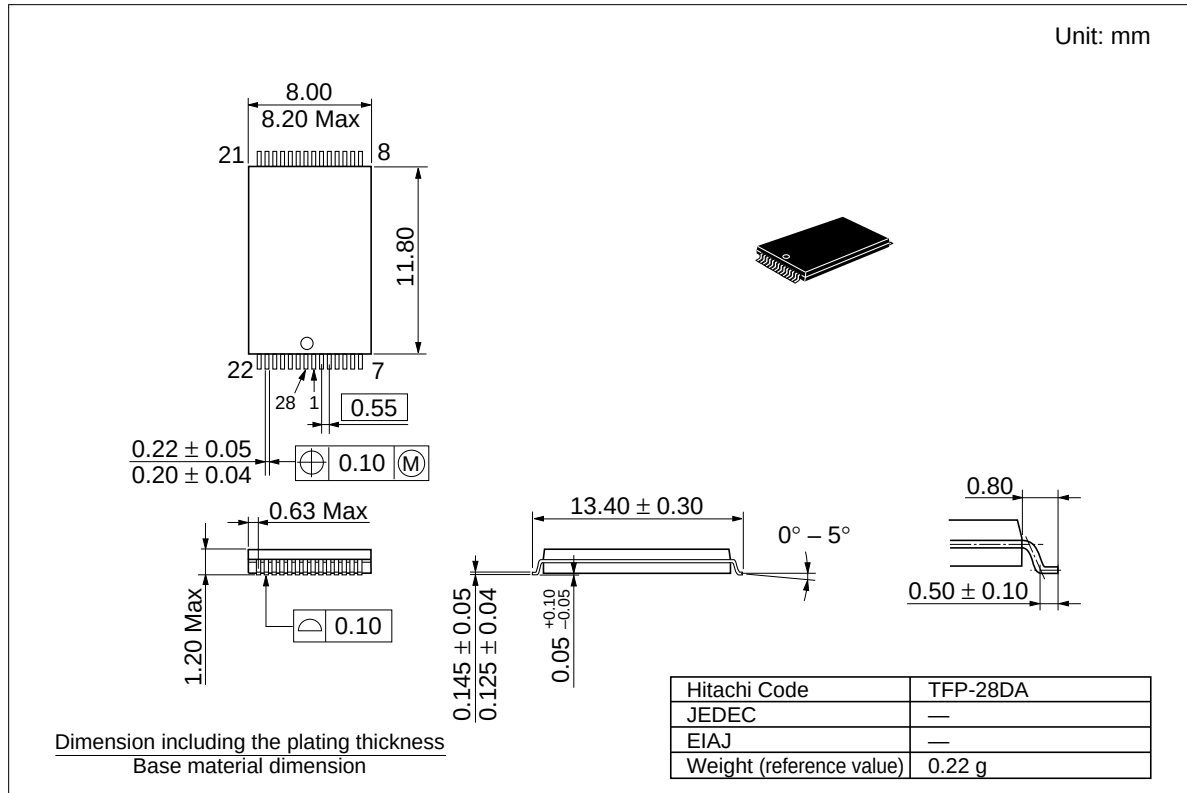
HM62W256LT Series (TFP-32DA)



HM62W256 Series

Package Dimensions

HM62W256LTM Series (TFP-28DA)



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HM62W256 Series

Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
0.0	Mar. 27, 1992	Initial issue	Y. Saito	Y. Kawashima
1.0	Dec. 20, 1992	Full specification	Y. Saito	Y. Kawashima
2.0	Feb. 25, 1993	Addition of HM62W256LT Series	Y. Saito	Y. Kawashima
3.0	Apr. 1, 1993	Operation Supply Voltage: 3.0V – 3.6 V to Single 3.3 V Supply f = 2 MHz to f = 1 MHz Function Table Not selected to Standby Absolute Maximum Rating Relative to V_{CC} to Relative to V_{SS} DC Characteristics I_{CCAC2} Cycle time: 500 ns to 1 μ s Low V_{CC} Data Retention Timing Waveforms Change of Notes	K. Imato	T. Matumoto
4.0	Sep. 10, 1993	Absolute Maximum Rating $V_T = -0.5$ to $V_{CC} + 0.5$ V to -0.5 to $V_{CC} + 0.3$ V DC Characteristics I_{CCDC1} (max): 5.0 mA to 15 mA I_{CCDC2} (max): 2.5 mA to 10 mA AC Characteristics tDW (min): 30/40 ns to 30/35 ns Addition of notes for Low V_{CC} Data retention Timing Waveform	Y. Saito	K. Yoshizaki
5.0	Mar. 18, 1994	DC Characteristics I_{CCAC2} (max): 10 mA to 15 mA	Y. Saito	K. Yashizaki
6.0	Oct. 31, 1994	Addition of HM62W256LTM Series (TFP-28DA) Addition of Block Diagram AC Characteristics Addition of note 12 Low V_{CC} data retention characteristics I_{CCDR} (typ): $-/-$ μ A to 0.2/0.2 μ A Note 2: 20 μ A max at $T_a = 0$ to 40°C to 10 μ A max at $T_a = 0$ to 40°C	Y. Saito	K. Yoshizaki
7.0	Jun. 19, 1995	Feature Low power (standby): 0.66 μ W to 0.33 μ W Deletion of HM62W256LFP-8T Deletion of HM62W256LT-8 Deletion of HM62W256LTM-8 Addition of HM62W256LFP-5SLT/7ULT Addition of HM62W256LTM-5SLT/7ULT Change of Block Diagram Absolute maximum Ratings Terminal voltage V_T : -0.5 to $V_{CC} + 0.3$ V to -0.5 to $V_{CC} + 0.5$ V	M. Higuchi	K. Yoshizaki

Revision Record (cont)

Rev.	Date	Contents of Modification	Drawn by	Approved by
7.0	Jun. 19, 1995	DC Characteristics Addition of note 3. I_{CCAC1} (max): 30/27 mA to 30/30/27 mA I_{SB1} (typ): 0.2/0.2/ μ A to 0.1/0.1/0.1 μ A I_{SB1} (max): 50/10 μ A to 50/10/5 μ A Capacitance C_{in} (max): 8 pF to 5 pF $C_{I/O}$ (max): 10 pF to 8 pF AC Characteristics Addition of Output timing reference level: HM62W256-5: 1.4 V Change order of notes t_{RC} (min): 70/85 ns to 55/70/85 ns t_{AA} (max): 70/85 ns to 55/70/85 ns t_{ACS} (max): 70/85 ns to 55/70/85 ns t_{OE} (max): 35/45 ns to 30/35/45 ns t_{CLZ} (min): 10/10 ns to 5/10/10 ns t_{OLZ} (min): 5/5 ns to 5/5/5 ns t_{CHZ} (max): 25/30 ns to 20/25/30 ns t_{OHZ} (max): 25/30 ns to 20/25/30 ns t_{OH} (min): 10/10 ns to 10/10/10 ns t_{WC} (min): 70/85 ns to 55/70/85 ns t_{CW} (min): 60/75 ns to 45/60/75 ns t_{AW} (min): 60/75 ns to 45/60/75 ns t_{WP} (min): 50/55 ns to 40/50/55 ns t_{WHZ} (max): 25/30 ns to 25/25/30 ns t_{DW} (min): 30/35 ns to 30/30/35 ns t_{OW} (min): 10/10 ns to 10/10/10 ns Low VCC Data Retention Characteristics I_{CCDR} (typ): 0.2/0.2 μ A to 0.05/0.05/0.05 μ A I_{CCDR} (max): 30/8 μ A to 30/8/3 μ A	M. Higuchi	K. Yoshizaki
8.0	Nov. 1997	Change of Format Change of Subtitle		
